

Features

- Trench Power LV MOSFET technology
- High density cell design for Low $R_{DS(ON)}$
- High Speed switching

Product Summary

V_{DS}	$R_{DS(ON)}\text{ MAX}$	$I_D\text{ MAX}$
-30V	18mΩ@-10V	-15A
	30mΩ@-4.5V	

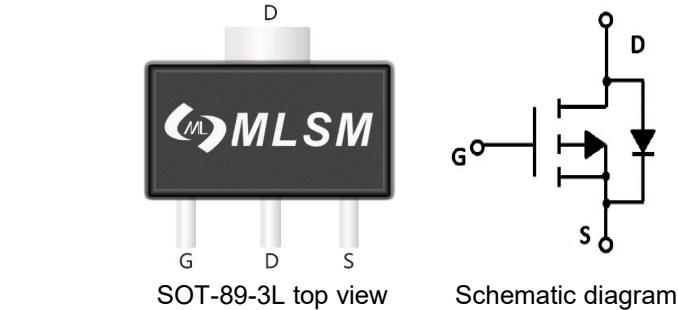
Application

- Battery protection
- Power management
- Load switch



0D15AP : Device code
XXXX : Code

Marking and pin assignment



Absolute Maximum Ratings (TA=25°C unless otherwise noted)

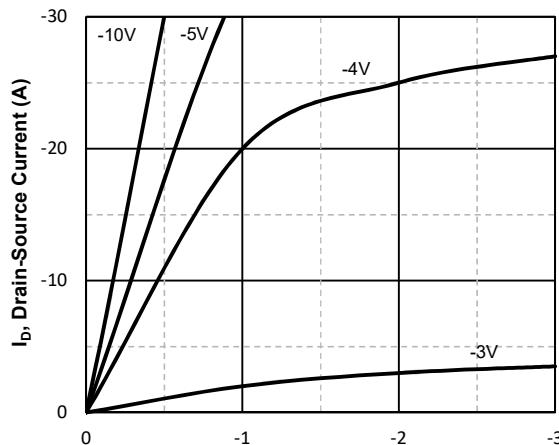
Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V_{DS}	Drain-Source Breakdown Voltage	-30	V
V_{GS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 155	°C
I_S	Diode Continuous Forward Current	Tc=25°C -15	A
Mounted on Large Heat Sink			
I_{DM}	Pulse Drain Current Tested	Tc=25°C -60	A
I_D	Continuous Drain Current	Tc=25°C -15	A
P_D	Maximum Power Dissipation	Tc=25°C 1.7	W
$R_{θJA}$	Thermal Resistance Junction-Ambient	315	°C/W

Ordering Information (Example)

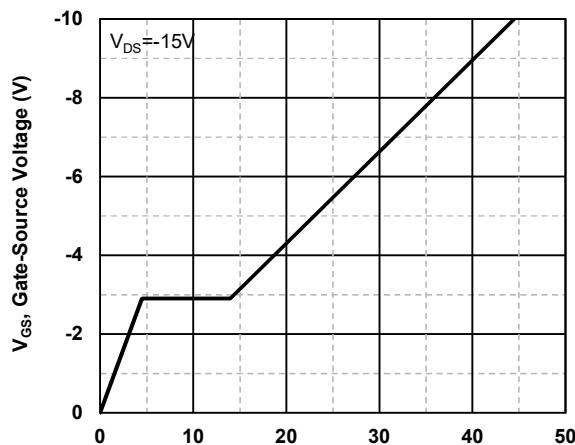
Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MZ0D15AP	SOT-89-3L	0D15AP	1,000	10,000	40,000	7"reel

Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-30	--	--	V
I _{BS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.8	-1.5	-2	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-15A	--	12	18	mΩ
		V _{GS} =-4.5V, I _D =-7A	--	22	30	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz	--	2400	--	pF
C _{OSS}	Output Capacitance		--	315	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	260	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DD} =-15V, I _D =-15A, V _{GS} =-10V	--	44.5	--	nC
Q _{gs}	Gate Source Charge		--	4..5	--	nC
Q _{gd}	Gate Drain Charge		--	10	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-15V, I _D =-15A, V _{GS} =-10V, R _G =2.5Ω	--	9	--	nS
t _r	Turn-on Rise Time		--	8	--	nS
t _{d(off)}	Turn-Off Delay Time		--	28	--	nS
t _f	Turn-Off Fall Time		--	10	--	nS
Source-Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =-15A	--	--	-1.2	V

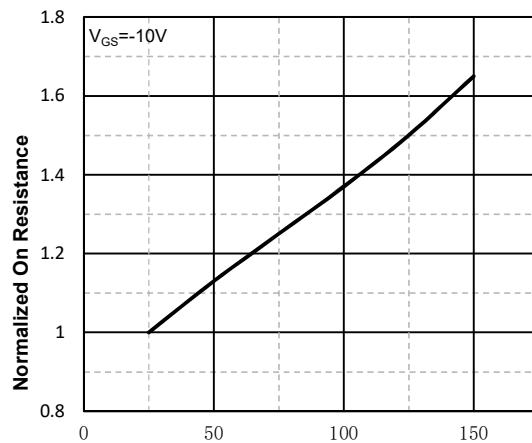
Typical Operating Characteristics



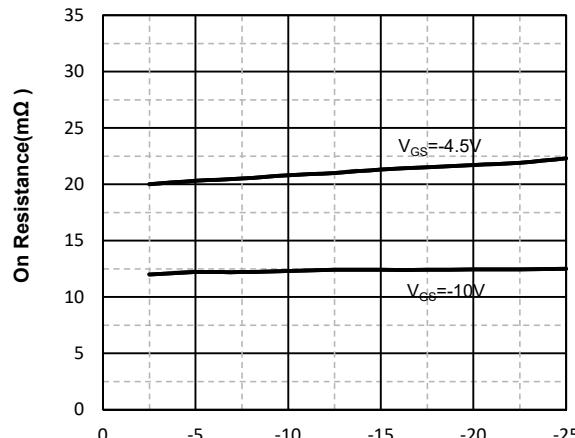
V_{DS} , Drain -Source Voltage (V)
Fig1. Typical Output Characteristics



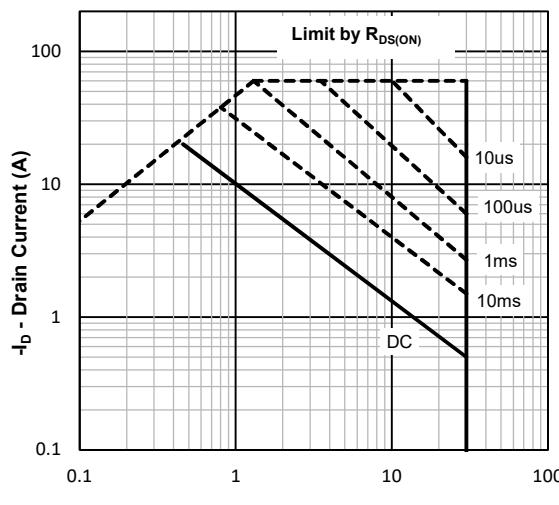
Q_g -Total Gate Charge (nC)
Fig2. Typical Gate Charge Vs.Gate-Source Voltage



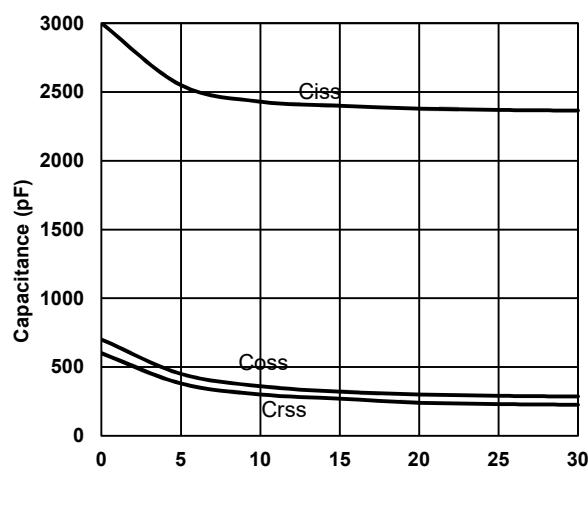
T_j - Junction Temperature (°C)
Fig3. Normalized On-Resistance Vs. Temperature



I_D , Drain-Source Current (A)
Fig4. On-Resistance Vs. Drain-Source Current

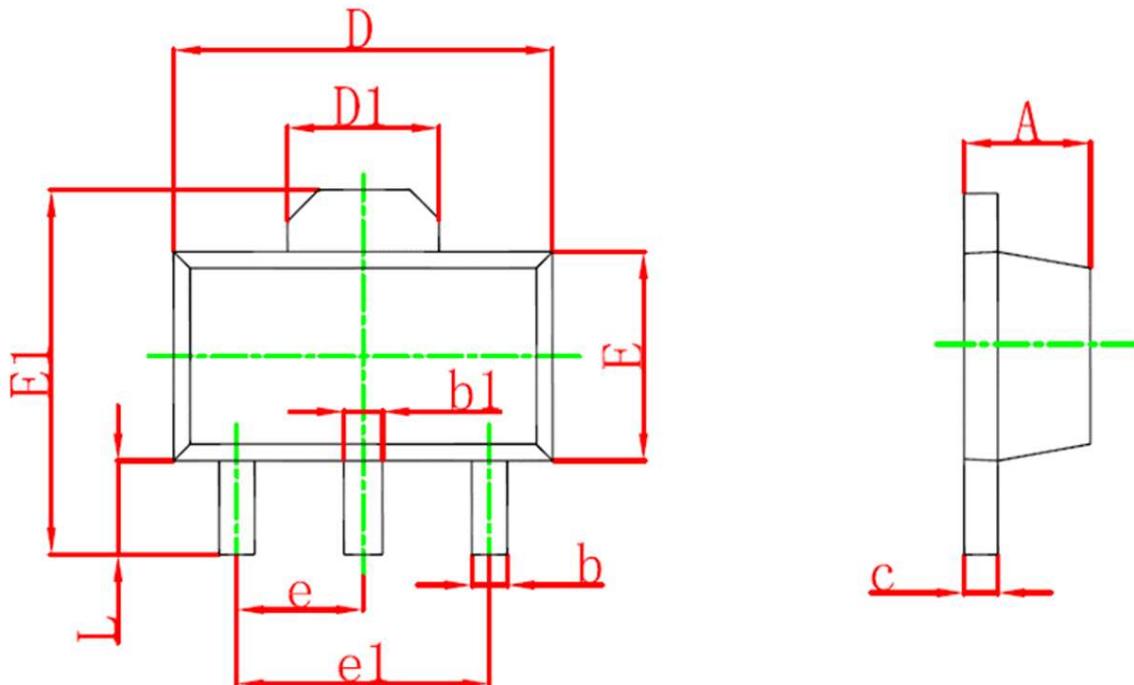


I_D - Drain Current (A)
Fig5. Maximum Safe Operating Area



V_{DS} , Drain-Source Voltage (V)
Fig6 Typical Capacitance Vs.Drain-Source Voltage

SOT-89-3L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions in Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF		0.061 REF	
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP		0.060 TYP	
e1	3.000 TYP		0.118 TYP	
L	0.900	1.200	0.035	0.047